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# 2SJ389(L), 2SJ389(S)

Silicon P-Channel MOS FET

## HITACHI

November 1996

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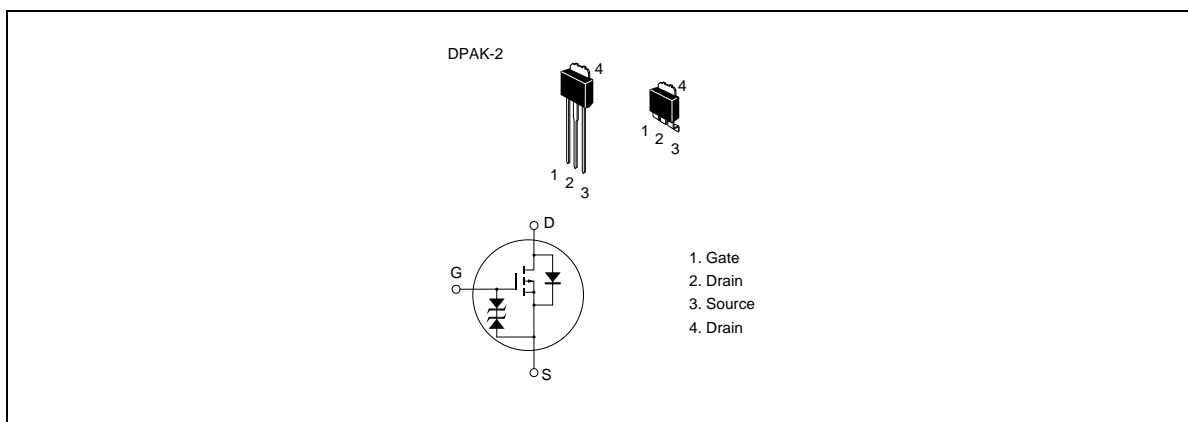
### Application

High speed power switching

### Features

- Low on-resistance
- High speed switching
- Low drive current
- 4 V gate drive device can be driven from 5 V source
- Suitable for Switching regulator, DC - DC converter
- Avalanche Ratings

### Outline



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### Absolute Maximum Ratings (Ta = 25°C)

Item	Symbol	Ratings	Unit
Drain to source voltage	$V_{DSS}$	-60	V
Gate to source voltage	$V_{GSS}$	±20	V
Drain current	$I_D$	-10	A
Drain peak current	$I_{D(pulse)}^{*1}$	-40	A
Body to drain diode reverse drain current	$I_{DR}$	-10	A
Avalanche current	$I_{AP}^{*3}$	-10	A
Avalanche energy	$E_{AR}^{*3}$	8.5	mJ
Channel dissipation	$Pch^{*2}$	30	W
Channel temperature	Tch	150	°C
Storage temperature	Tstg	-55 to +150	°C

- Notes
1.  $PW \leq 10 \mu s$ , duty cycle  $\leq 1\%$
  2. Value at Tc = 25°C
  3. Value at Tch = 25°C, Rg  $\geq 50 \Omega$

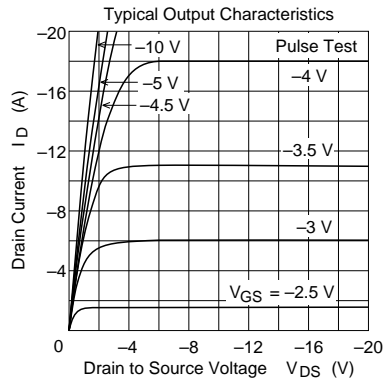
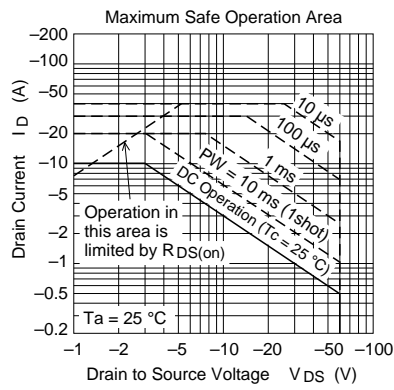
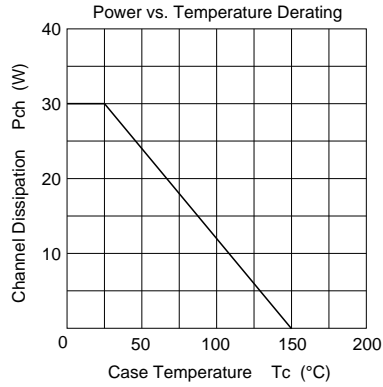
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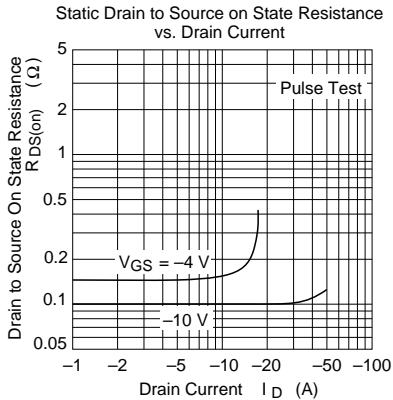
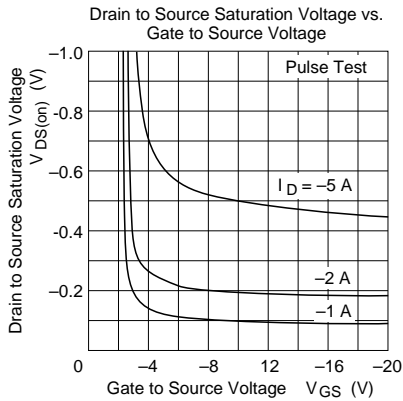
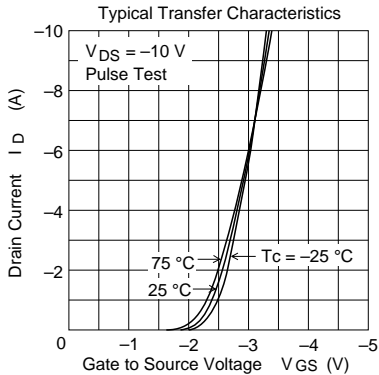
### Electrical Characteristics (Ta = 25°C)

Item	Symbol	Min	Typ	Max	Unit	Test conditions
Drain to source breakdown voltage	$V_{(BR)DSS}$	-60	—	—	V	$I_D = -10 \text{ mA}, V_{GS} = 0$
Gate to source breakdown voltage	$V_{(BR)GSS}$	±20	—	—	V	$I_G = \pm 100 \text{ } \mu\text{A}, V_{DS} = 0$
Gate to source leak current	$I_{GSS}$	—	—	±10	μA	$V_{GS} = \pm 16 \text{ V}, V_{DS} = 0$
Zero gate voltage drain current	$I_{DSS}$	—	—	-100	μA	$V_{DS} = -50 \text{ V}, V_{GS} = 0$
Gate to source cutoff voltage	$V_{GS(off)}$	-1.0	—	-2.25	V	$I_D = -1 \text{ mA}, V_{DS} = -10 \text{ V}$
Static drain to source on state resistance	$R_{DS(on)}$	—	0.1	0.135	Ω	$I_D = -5 \text{ A}$ $V_{GS} = -10 \text{ V}^{*1}$
		—	0.14	0.2	Ω	$I_D = -5 \text{ A}$ $V_{GS} = -4 \text{ V}^{*1}$
Forward transfer admittance	$ y_{fs} $	4	8	—	S	$I_D = -5 \text{ A}$ $V_{DS} = -10 \text{ V}^{*1}$
Input capacitance	Ciss	—	910	—	pF	$V_{DS} = -10 \text{ V}$
Output capacitance	Coss	—	440	—	pF	$V_{GS} = 0$
Reverse transfer capacitance	Crss	—	170	—	pF	f = 1 MHz
Turn-on delay time	$t_{d(on)}$	—	15	—	ns	$I_D = -5 \text{ A}$
Rise time	$t_r$	—	85	—	ns	$V_{GS} = -10 \text{ V}$
Turn-off delay time	$t_{d(off)}$	—	220	—	ns	$R_L = 6 \text{ } \Omega$
Fall time	$t_f$	—	145	—	ns	
Body to drain diode forward voltage	$V_{DF}$	—	-1.0	—	V	$I_F = -10 \text{ A}, V_{GS} = 0$
Body to drain diode reverse recovery time	$t_{rr}$	—	170	—	μs	$I_F = -10 \text{ A}, V_{GS} = 0,$ $diF/dt = 50 \text{ A}/\mu\text{s}$

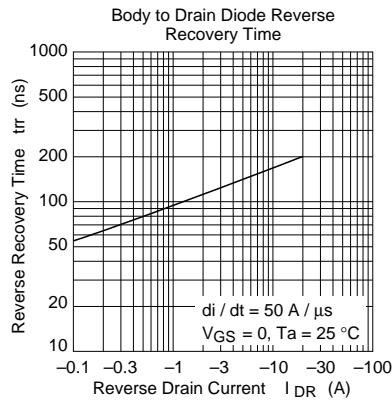
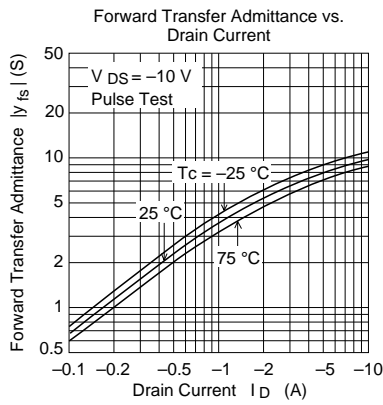
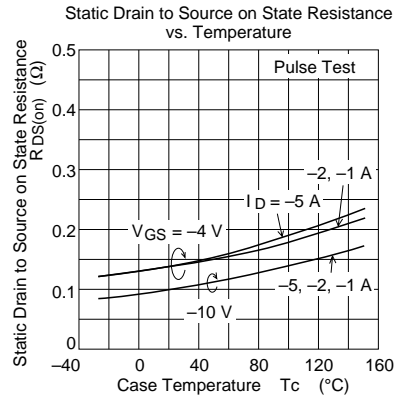
Note 1. Pulse Test

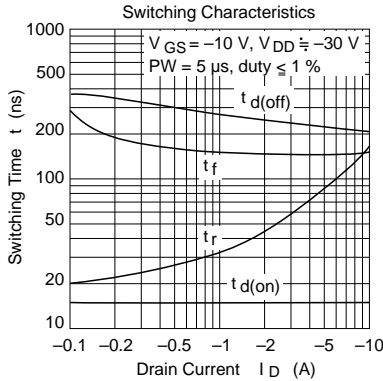
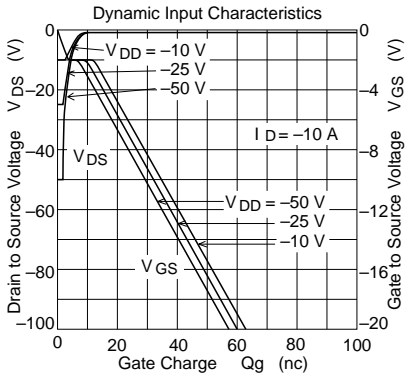
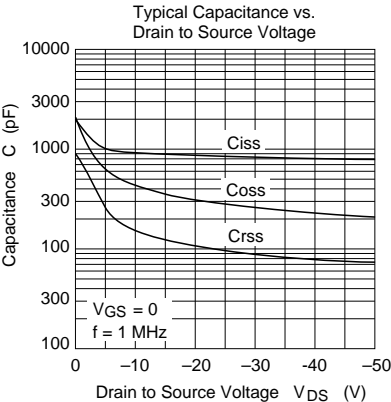
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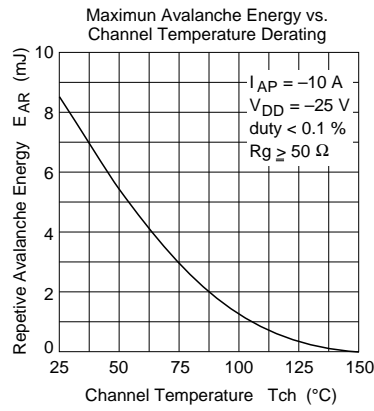
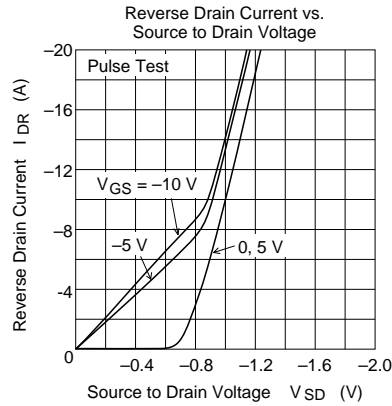


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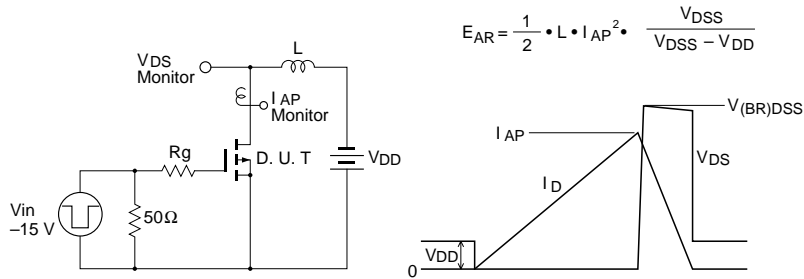




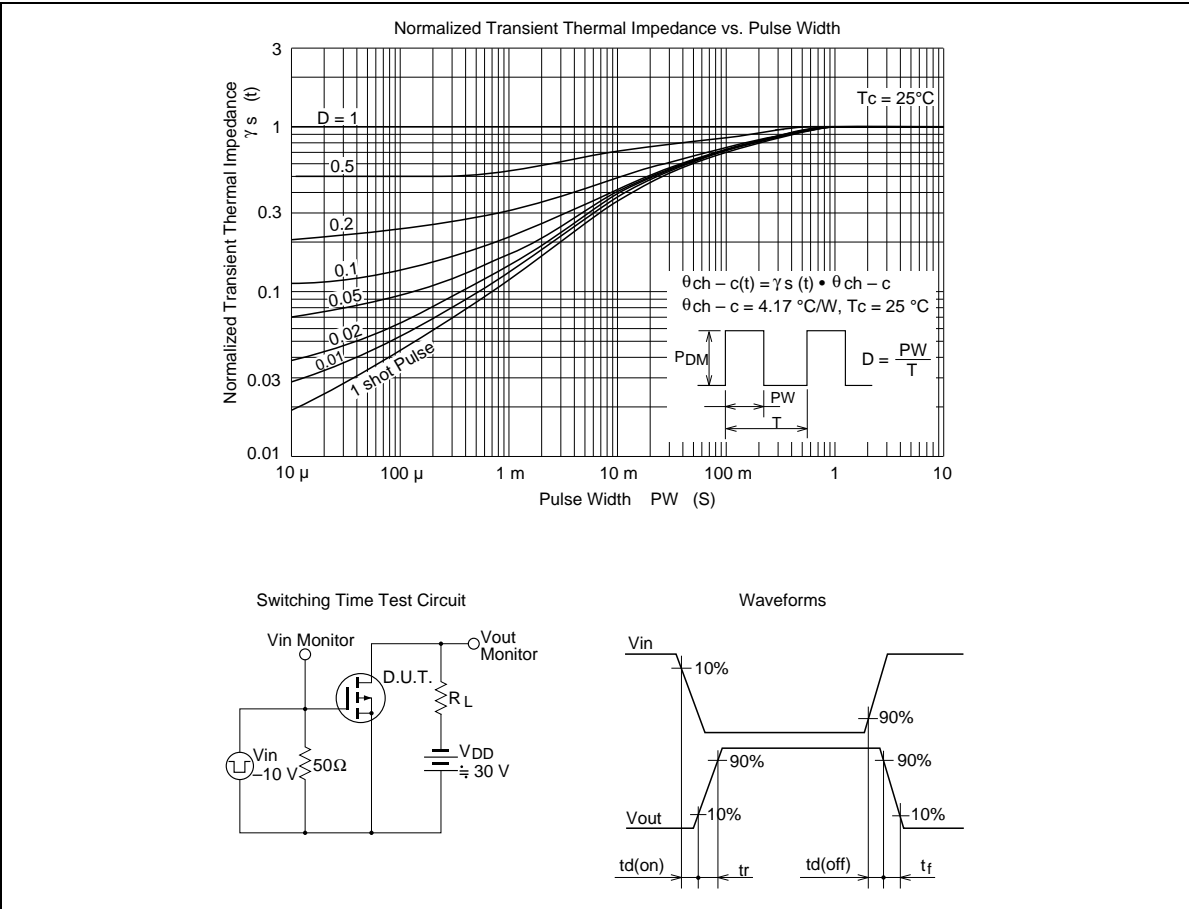
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Avalanche Test Circuit and Waveform







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## 2SJ389(L), 2SJ389(S)

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# HITACHI

**Hitachi, Ltd.**  
Semiconductor & IC Div.  
Nippon Bldg., 2-6-2, Ohte-machi, Chiyoda-ku, Tokyo 100, Japan  
Tel: Tokyo (03) 3270-2111  
Fax: (03) 3270-5109

**For further information write to:**

Hitachi America, Ltd.  
Semiconductor & IC Div.  
2000 Sierra Point Parkway  
Brisbane, CA. 94005-1835  
U S A  
Tel: 415-589-8300  
Fax: 415-583-4207

Hitachi Europe GmbH  
Electronic Components Group  
Continental Europe  
Dornacher Straße 3  
D-85622 Feldkirchen  
München  
Tel: 089-9 91 80-0  
Fax: 089-9 29 30 00

Hitachi Europe Ltd.  
Electronic Components Div.  
Northern Europe Headquarters  
Whitebrook Park  
Lower Cookham Road  
Maidenhead  
Berkshire SL6 8YA  
United Kingdom  
Tel: 0628-585000  
Fax: 0628-778322

Hitachi Asia Pte. Ltd.  
16 Collyer Quay #20-00  
Hitachi Tower  
Singapore 0104  
Tel: 535-2100  
Fax: 535-1533

Hitachi Asia (Hong Kong) Ltd.  
Unit 706, North Tower,  
World Finance Centre,  
Harbour City, Canton Road  
Tsim Sha Tsui, Kowloon  
Hong Kong  
Tel: 27359218  
Fax: 27306071